

Evaluation Board EPC9193 and EPC9193HC Quick Start Guide

*40 A_{RMS}, 3-phase BLDC Motor Drive Inverter using the
EPC2619 eGaN[®] FET*

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Version 1.1



DESCRIPTION

The EPC9193 evaluation board is a 3-phase BLDC motor drive inverter board featuring the EPC2619 eGaN FET, rated at 100 V with $4.2 \text{ m}\Omega R_{DS(on)_max}$. The EPC9193 is provided in two configurations. The standard configuration (EPC9193) uses a single FET for each switch position and the high current configuration (EPC9193HC) uses two paralleled FET's per switch position and can deliver up to 60 Apk (42 ARMS maximum output current). The board can also be configured for multi-phase DC-DC conversion and the EPC2619 supports PWM switching frequencies up to 250 kHz in motor drive applications and 500 kHz in DC-DC applications. The EPC9193 contains all the necessary critical functions circuits to support a complete motor drive inverter including gate drivers, regulated auxiliary power rails for housekeeping supplies, voltage, and temperature sense, accurate current sense, and protection functions. The various functional blocks are shown in figure 1. The EPC9193 mates with an assortment of compatible controllers, supported by various manufacturers leveraging existing resources for quick development purposes, that can quickly be configured as a motor drive inverter or DC-DC converter.

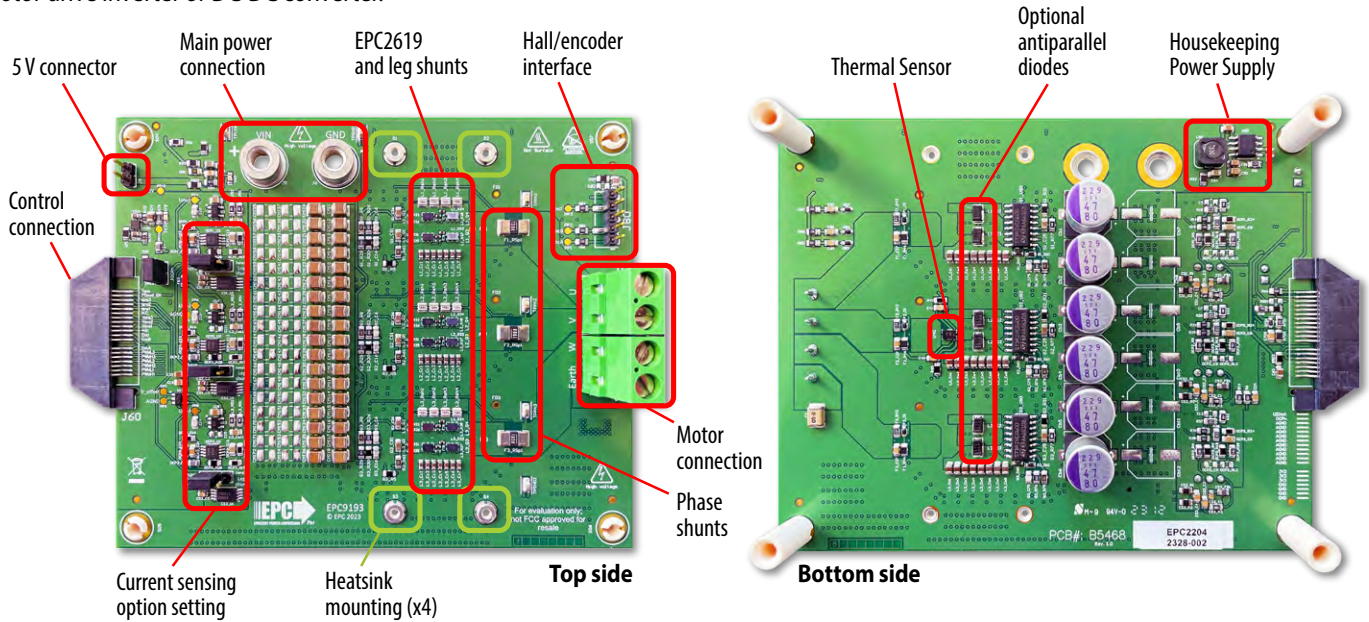


Figure 1: Photo overview of the EPC9193HC board highlighting the main sections

A functional block diagram of the EPC9193 evaluation board is shown in figure 2, that details the phase current sense, phase and DC voltage sense, the half-bridge power stages, housekeeping power supply and controller interface connection.

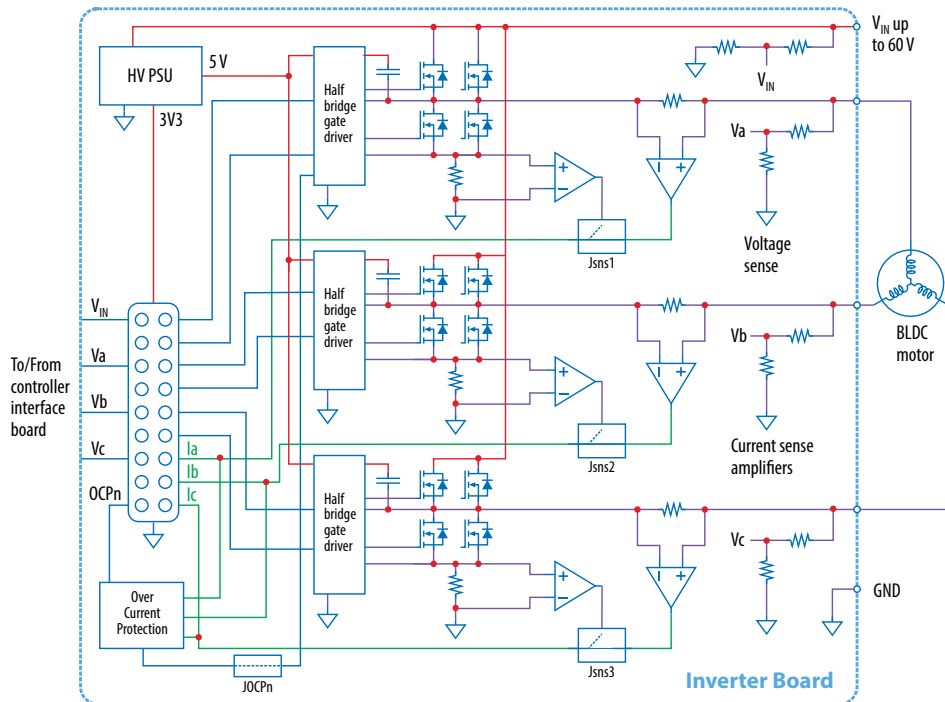
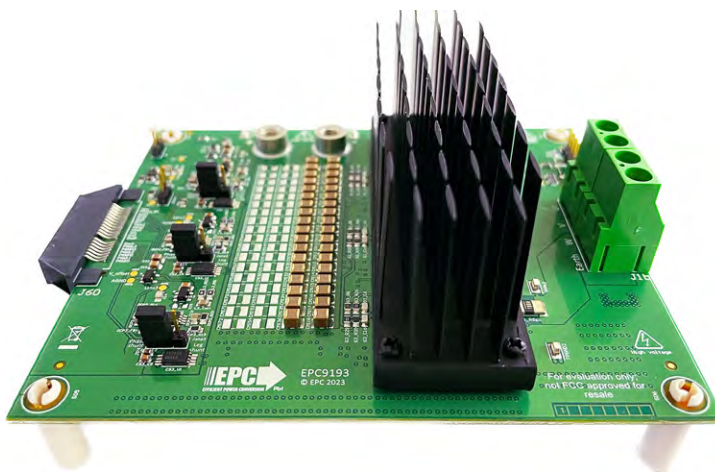


Figure 2. Block diagram of EPC9193HC board in BLDC drive example application

MAIN FEATURES

- 3-phase inverter based on EPC2619 eGaN FET with wide input DC voltage ranging from 14 V to 65 V
- Dimensions: L x W = 130 x 100 mm (including connector)
- Low distortion switching that keeps motor audio emission low and reduces torque ripple
- dv/dt optimized for motor drives less than 10 V/ns with option to increase dv/dt for DC-DC applications
- All current sense with high accuracy and bandwidth (option to choose between in-line and leg shunt current sensors)
- All phases voltage sense
- Voltage sense for the DC supply to the drive
- Housekeeping power for the various circuits and external controller derived from the main power supply to the EPC9193
- Temperature monitoring circuit
- Protection features including: over-current and input supply under voltage lockout
- Shaft encoder/Hall sensors interface connector for motor drive application with two voltage levels selection option
- The board can also be configured to operate as a synchronous buck DC-DC converter.



EPC9193 Evaluation board with heatsink attached

RECOMMENDED OPERATING CONDITIONS

Table 1: Electrical Specifications (T_A = 25°C) EPC9193HC and EPC9193

Symbol	Parameter	Conditions	Min	Nom	Max	Units
V _{IN}	Input supply voltage		14	48	65 ⁽⁵⁾	V
I _{Phase}	EPC9193HC Phase current ⁽¹⁾			25	40	A _{RMS}
	EPC9193 Phase current ⁽¹⁾			21	30	
f _{sw}	Switching frequency		50	100	250 ⁽⁴⁾	kHz
V _{IN_uvlo}	Input undervoltage lockout voltage			14		V
V _{IN_uvlo_hys}	Input undervoltage lockout voltage hysteresis			1.64		
V _{IH}	PWM high-level logic threshold	PWM rising edge	2.4			V
V _{IL}	PWM low-level logic threshold	PWM falling edge			0.8	
V _{IHyst}		V _{IH} Rising – V _{IL} Falling		0.5		
R _{in}	PWM input pulldown resistance			150		kΩ
PW _{min}	Minimum input pulse -width	50% level to 50% level – based on gate driver specs		120		ns
t _{Prop_delay}	PWM input to Switch-node transition delay	High-side/Low-side on/off		50		
V _{Isns_range}	Phase current sense voltage dynamic range	–I _{max} to I _{max}	0		3.3	V
I _{Isns_range}	Phase current sense dynamic range	Shunt = 1.0 mΩ, current sense amplifier gain = 20	-82.5		82.5	A
I _{ovc} ⁽²⁾	Positive over-current threshold	Over-current circuits detects both positive negative OVC		60		
V _{Isns_offset}	Amplified current sense signal offset voltage	Shunt = 1.0 mΩ, current sense amplifier gain = 20, I _{phase} = 0 A		1.65		V
G _{Isns}	Amplified current sense gain	Shunt = 1.0 mΩ, current sense amplifier gain = 20. V _{Isns} – V _{Isns_offset} is positive when current enters the inverter		20		mV/A
G _{Vsns}	Phase and DC voltage sense gain ⁽³⁾			40.5		mV/V

(1) Maximum current depends on die temperature – actual maximum current is affected by switching frequency, bus voltage and thermal cooling. Refer to thermal performance section in this guide and to [EPC2619 data sheet](#) for details.

(2) All phases over-current is monitored. Over-current signal is sent to the controller connector via R60. Insert JOCPn to disable PWM when over-current is detected

(3) **Maximum dynamic voltage range is 0 V to 113 V which exceeds maximum recommended supply voltage for the EPC2619 eGaN IC.**

(4) Higher frequency operation up to 500 kHz in DC-DC mode is possible.

(5) Limited by capacitors

HIGHLIGHTED PARTS

Power Stage

The EPC9193 features a 3-phase inverter with EPC2619 eGaN FET and gate drivers. For more information on the EPC2619 please refer to the datasheet available from EPC at www.epc-co.com. The datasheet should be read in conjunction with this quick start guide.

Onboard power supply

The EPC9193 board includes logic and gate driver house-keeping power supplies that are powered from the main input supply voltage to the inverter board. The 3.3 V controller supply voltage is also provided to the controller connector (J60) and can be disconnected by removing a resistor (R803).

Current and voltage sense

The EPC9193 inverter is equipped with voltage and current sense for all phases and voltage sense for the DC input.

Output current is measured in-line using a 1.0 mΩ shunt (Fx_Rsp1) that is amplified using the INA240A1 (CSx_U1) bi-directional current sense amplifier that yields a total gain of 20 mV/A. The bandwidth of the current sense amplifier is 400 kHz which is adequate for accurate motor control operation at 100 kHz switching frequency.

The output current can be also measured using 4x 4.0 mΩ leg shunts (equivalent to 1.0 mΩ leg shunt) that are amplified with a total gain of 20 mV/A and an offset of 1.65 V. By inserting the jumper (Jsnsx) in proper position, the user can choose seamlessly between in-phase or leg shunt current sensing. In all configurations, the shunt amplifiers are bi-directional ensuring the full four quadrant operation is covered.

The main input DC supply voltage and each phase voltage are measured using a resistor divider network that yields a total gain of 40.5 mV/V.

Temperature sensor

The EPC9193 board is equipped with a temperature sensor (U40 – AD590) that is centrally located on the bottom of the board that reports an analog voltage reading proportional to the measured temperature using the following equation that was confirmed through characterization of the EPC9193 board :

$$T = \left(\frac{V \cdot 1000}{7.87} \right) - 273.16 \text{ [}^\circ\text{C]}$$

Connection and controller mate options

A 40 pin connector is used to interface power, PWM signals and analog feedback signals between the interface control board and the EPC9193 motor drive inverter. Table 2 gives the map (J60) for each signal.

LED indicators

The EPC9193 has a number of LED indicators indicating the presence of the various supply voltages as follows:

- 5 V LED (green) – indicates the 5 V supply is operational
- 3.3 V LED (yellow) – indicates the 3.3 V supply is operational

Table 2: Controller interface connection (J60) pin assignment map

Pin #	Pin name		Pin #
2	PWMH1	GND	1
4	PWML1	GND	3
6	PWMH2	GND	5
8	PWML2	GND	7
10	PWMH3	3V3 ⁽¹⁾	9
12	PWML3	3V3 ⁽¹⁾	11
14	EncA	3V3 ⁽¹⁾	13
Index Slot			
18	EncB	AGND	17
20	EncI	AGND	19
22	Vdc	AGND	21
24	Vsns1	AGND	23
26	Vsns2	AGND	25
28	Vsns3	AGND	27
30	N.C.	AGND	29
32	Isns1	AGND	31
34	Isns2	AGND	33
36	Isns3	AGND	35
38	EN/Pgood	OC_FLT/ ⁽²⁾	37
40	Tsns	LEDact	39

⁽¹⁾ 3.3 V is connected through the resistor R803 (installed by default)

⁽²⁾ OC_FLT/ is connected through the resistor R60 (installed by default)

Test Points

A number of test-points are available for easy measurement of various nodes as follows:

- Touch-point pad for the 5 V supply
- Touch-point pad for the 3.3 V supply
- Touch-point pad for the Over-current detect
- A SMD hookup for each phase voltage
- A Touch-point for each amplified current signal (after jumper choice)
- Touch-point pad for the shaft encoder A or Hall_A signal
- Touch-point pad for the shaft encoder B or Hall_B signal
- Touch-point pad for the shaft encoder Index or Hall_C signal

All analog signals are measured with respect to analog ground (AGND) using a Touch/point pad. All digital signals are measured with respect to digital ground (GND) using a SMD hookup. All the test point locations are shown in figure 3.

Over-current protection

The EPC9193 includes an overcurrent detect circuit that triggers if any of the three phases current measurement exceeds 50 A. Once an over-current is triggered, the active low OC signal will remain low for a short period of time, determined by the RC time constant (3.6 μ s) of R29 and C16 and all PWM signals will be disconnected to the gate drivers if jumper JOCPn is installed. The OC detect signal can be passed on to the controller as OC_FLT through R60 (installed by default). The OC signal should not be loaded by the controller and a high input impedance circuit must be used to read the status. Loading the OC signal will affect the reset time or could place the inverter in permanent over-current state.

Jumper Settings

The EPC9193 is provided with two jumpers with functions given in table 3.

Table 3: Jumper settings function

Jumper	Installed	Open
JOCPn	The over-current detection circuit disables the PWM signals independently from microcontroller	The over-current detection circuit does not disable the PWM signals independently from microcontroller. In this case R60 must be mounted and the microcontroller must promptly react to over-current detection
Jsnx	Position 1-2 leg shunt current sensing analog signal selected Position 2-3 in phase current sensing analog signal selected (Pin 3 of Jsnx is near control connector)	Not allowed. The jumpers Jsnx1, Jsnx2 and Jsnx3 must be installed in any of the two possible positions.

Any combination of valid position settings may be selected.

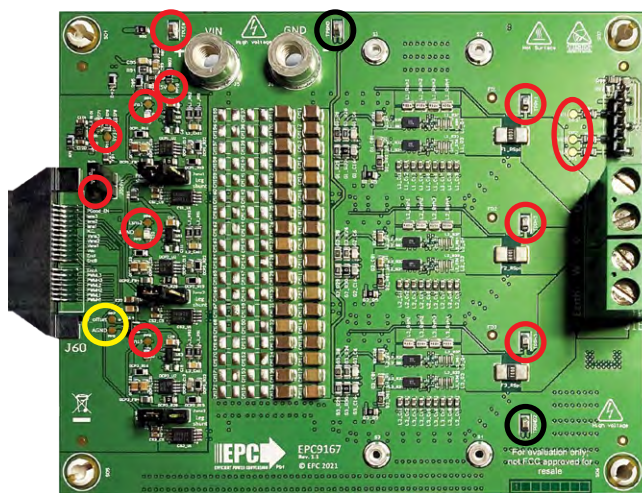


Figure 3: EPC9193 test point pad and hookup locations and designations. In black the PGND reference points and in yellow the AGND reference point.

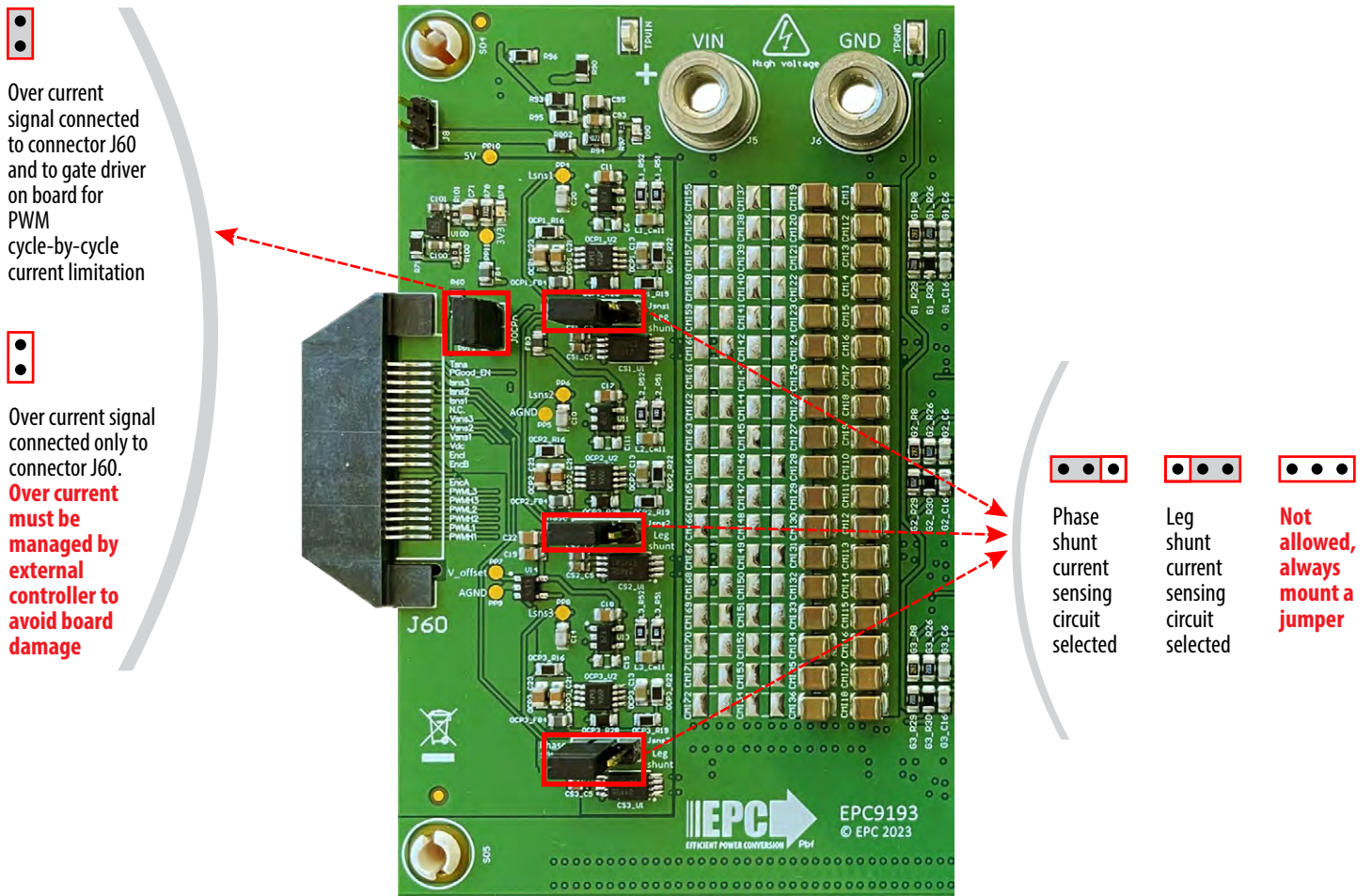


Figure 4: Over-current and current sensing circuits jumper settings

Shaft Encoder / Hall effect sensors

Connector (J80) is used to connect a shaft sensor to the EPC9193 motor drive inverter that is compatible with optical quadrature encoders or hall effect sensors and provides supply voltage for the encoder. The available voltage selections can be made by installing the applicable resistors as follows: 5 V using R81 (default), and 3.3 V using R82. The filtered signals are then provided to the controller connector (J60).

Compatible Controllers

A list of compatible controllers for the EPC9193 is given in table 4 for both Motor drive and DC-DC applications.

Table 4: Compatible controller interface and controller boards to the EPC9193

Controller Board Number	Controller Manufacturer	Controller	Target Application
EPC9147A - Rev.2.1	Microchip - MA330031-2	dsPIC33EP256MC506	Motor Drive
EPC9147B - Rev. 2.0	Texas Instruments - LAUNCHXL-F28379D	TMS320F2837xD	Motor Drive
EPC9147C - Rev. 2.2	ST Microelectronics	NUCLEO-G431 RB NUCLEO-G474RE	Motor Drive
EPC9147D – Rev. 1.0	Renesas - RTK0EMA270C00000BJ	RA6T2	Motor Drive
EPC9147E - Rev.2.0	Generic Interface board	N/A	Motor Drive or DC-DC converter
EPC9528 - Rev.3.0	Generic controller board	dsPIC33CK256MP503	DC-DC converter

APPLICATION CONFIGURATION

Motor Drive Inverter

A 3-phase BLDC motor drive inverter is the primary application case for which the EPC9193 board was designed for and can be used for either sensor-less or shaft encoder sensor configurations. The motor drive controller options are given in table 4 giving the user various mainstream choices that leverage existing resources to simplify and speed up development and evaluation. Figure 5 shows the simplicity of connecting a controller and motor to the EPC9193. **In the default configuration, the EPC9193 is paired with the EPC9147C that is pre-programmed to power and control a NEMA 34 size motor from Teknic M-3411P-LN-08D**, with DC supply voltage of 48 V using sensor-less field orientated control with space vector pulse width modulation (SVPWM).

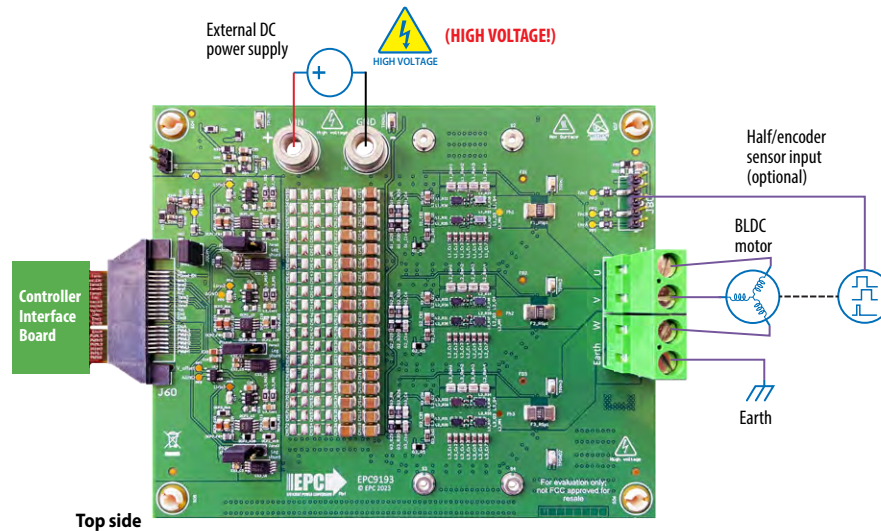


Figure 5: Connection diagram of the EPC9193 configured as a motor drive inverter

QUICK START PROCEDURE

For this quick start procedure only the **motor drive application** using the EPC9147C controller is presented.

Follow the procedure below to operate the specific motor Teknic M-3411P-LN-08D with EPC9193 and controller board:

1. Mate the EPC9193 with an applicable controller interface board as given in table 4. Review the QSG of corresponding control interface board for detailed operating procedures. For this procedure, the EPC9147C is used.
2. Connect the correct motor, whose parameters are programmed into the controller, to the EPC9193 at connector J1 and the DC power supply at connectors J5 and J6 (**Observe correct polarity, there is no inverse polarity protection on board**) and shown in figure 5.
3. Preset the main supply voltage to the operating voltage and turn on and observe the power LEDs illuminate. Press the Start/Stop button to start the motor spinning. Additional controls are available using ST Microelectronics motor control software. Please review the [EPC9147C QSG](#) for details.
4. Once operational, make the necessary measurements.
5. For shutdown, press the Start/Stop button to stop the motor spinning, then turn off the main DC power supply.

THERMAL CONSIDERATIONS

The EPC9193 is intended for bench evaluation at room ambient temperatures and under either natural convection or forced air cooling. The addition of a heatsink can significantly improve the heat dissipation from the eGaN FETs and increase the current capacity of these devices, while ensuring to not exceed the absolute maximum die temperature of 150°C.

The EPC9193 board is equipped with four mechanical spacers (51, 52, 53, 54) that can be used to easily attach a standard quarter-brick converter heatsink as shown in figures 8 and 9, and only requires a thermal interface material (TIM), a heatsink, and screws.

The heatsink is held in place using screws that fasten to the mechanical spacers which will accept 10 mm long M2 x 0.4 mm thread screws such as McMasterCarr 95836A113.

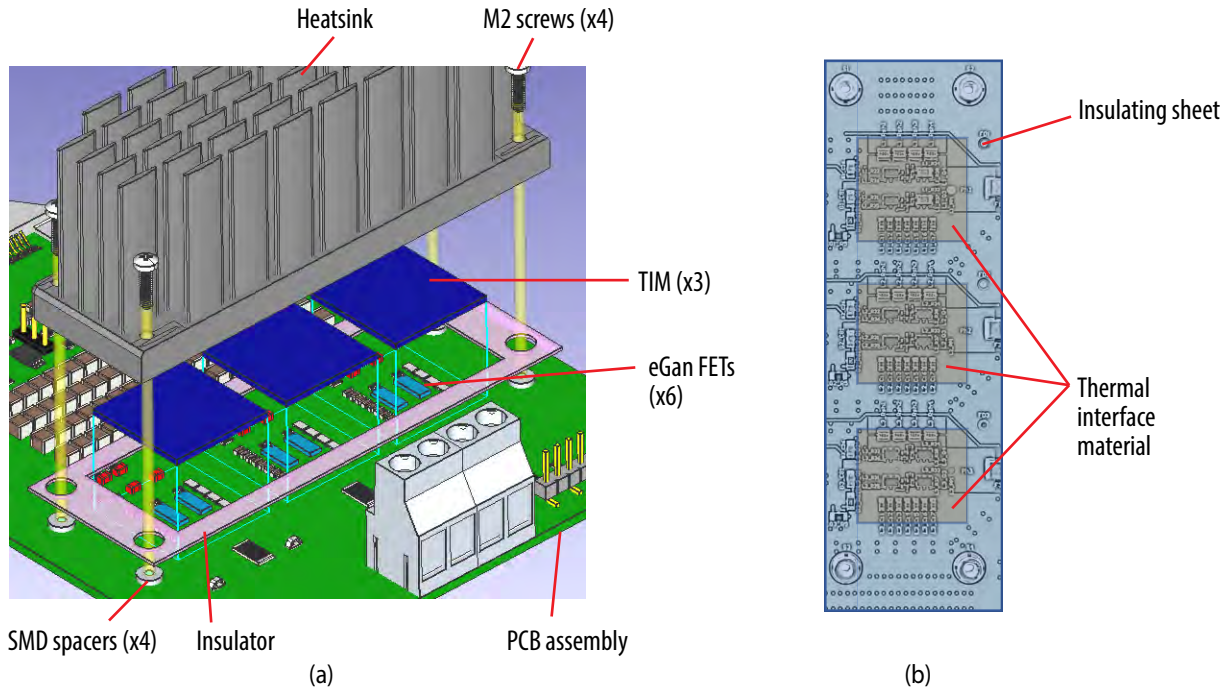


Figure 6: Details for attaching a heatsink to the board. (a) exploded 3D perspective, (b) top view showing the insulator sheet details with opening for the TIM with location of the eGaN FETs

When assembling the heatsink, it is necessary add a thin insulating layer to prevent the heat-spreader from short circuiting with components that have exposed conductors such as capacitors and resistors, as shown in figure 6 and 7. Note that the heatsink is ground connected. A rectangular opening in the insulator must be provided to allow the TIM to be placed over the FETs to be cooled with a minimum clearance of 3 mm on each side of the rectangle encompassing the FETs. The TIM will then be similar in size or slightly smaller than the opening in the insulator shown by the red dashed outline in figure 9. The insulator sheet material is made by Laird P/N A14692-30 Tgard K52 with thickness of 0.051 mm (0.0020”).

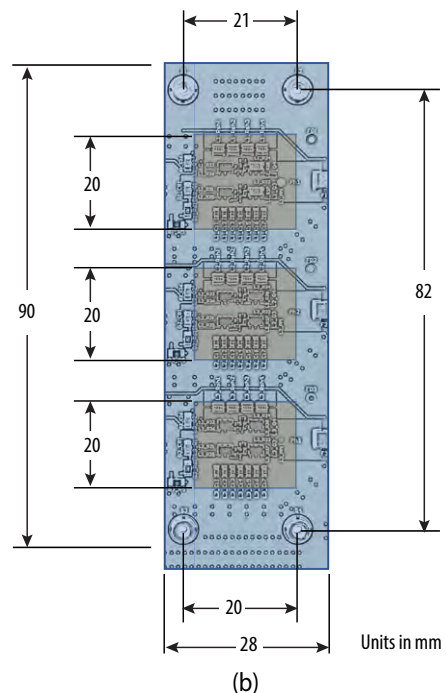


Figure 7: (a) minimum TIM coverage area (b) Insulator sheet details

A TIM is added to improve the interface thermal conductance between the GaN ICs and the attached heatsink. The choice of TIM needs to consider the following characteristics:

- **Mechanical compliance** – During the attachment of the heat spreader, the TIM underneath is compressed from its original thickness to the vertical gap distance between the spacers and the FETs. This volume compression exerts a force on the FETs. A maximum compression of 2:1 is recommended for maximum thermal performance and to constrain the mechanical force which maximizes thermal mechanical reliability.
- **Electrical insulation** – The backside of the eGaN FET is a silicon substrate that is connected to source and thus the upper FET in a half-bridge configuration is connected to the switch-node. To prevent short-circuiting the switch-node to the grounded thermal solution, the TIM must be of high dielectric strength to provide adequate electrical insulation in addition to its thermal properties.
- **Thermal performance** – The choice of thermal interface material will affect the thermal performance of the thermal solution. Higher thermal conductivity materials is preferred to provide higher thermal conductance at the interface.

EPC recommends the following thermal interface materials:

- **t-Global** P/N: TG-A1780 x 0.5 mm (highest conductivity of 17.8 W/m-K)
- **t-Global** P/N: TG-A6200 x 0.5 mm (moderate conductivity of 6.2 W/m-K)
- **Bergquist** P/N: GP5000-0.02 (~0.5 mm with conductivity of 5 W/m-K)
- **Bergquist** P/N: GPTGP7000ULM-0.020 (conductivity of 7 W/m-K)

The default TIM used for the EPC9193 is made by t-Global Technology, measures 20 x 20 x 0.5 mm thick with P/N TG-A6200-20-20-0.5
 The natural convection cooling heatsink used for the EPC9193 is Alpha Novatech, Inc., model # LPD2790-35BM-3V6; the forced air cooling heatsink is made by **Advanced Thermal Solutions, model # ATS-2862-C1-R0**.

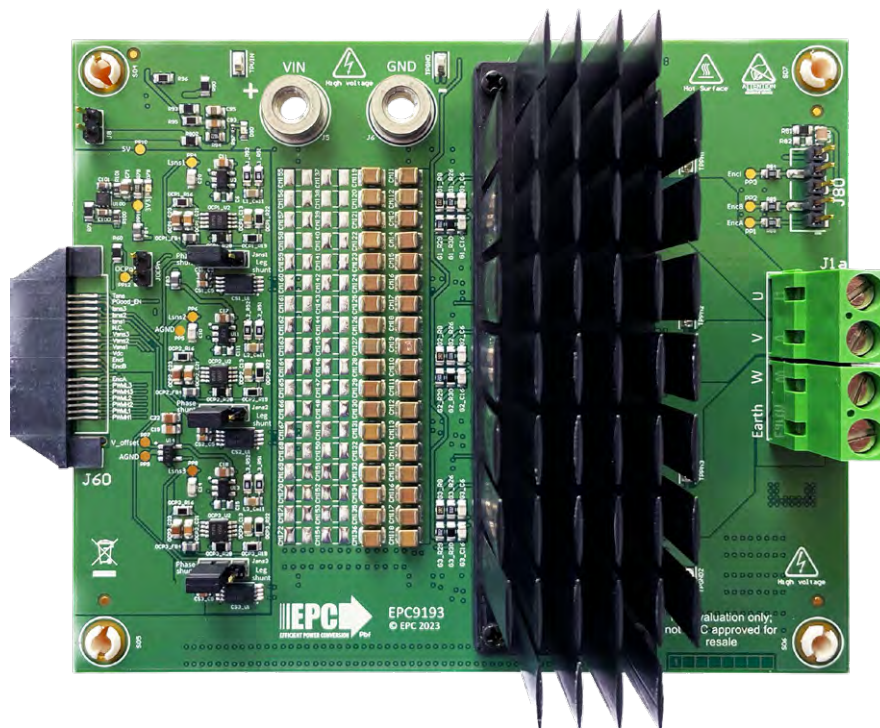


Figure 8: Natural convection cooling heatsink installed on the EPC9193 inverter board

EXPERIMENTAL VALIDATION EXAMPLE

The EPC9193HC motor drive inverter, paired with the EPC9147C interface controller, was operated from a 48 V_{DC} supply voltage while switching at 50 kHz, 50 ns dead-time setting, powering a 500 W motor with a sinusoidal modulation frequency of 5 Hz and delivering to the motor a phase current of 10 A_{RMS} with heat sink at a steady state.

MEASURED PHASE LEG WAVEFORMS

Figure 9 shows the measured waveforms of EPC9193 while delivering 10 A_{RMS} into each motor phase at 48 V_{DC} Bus is shown in figure 9 with a temperature increase of 26 °C at a 26 °C ambient temperature (52 °C measured temperature on the board).

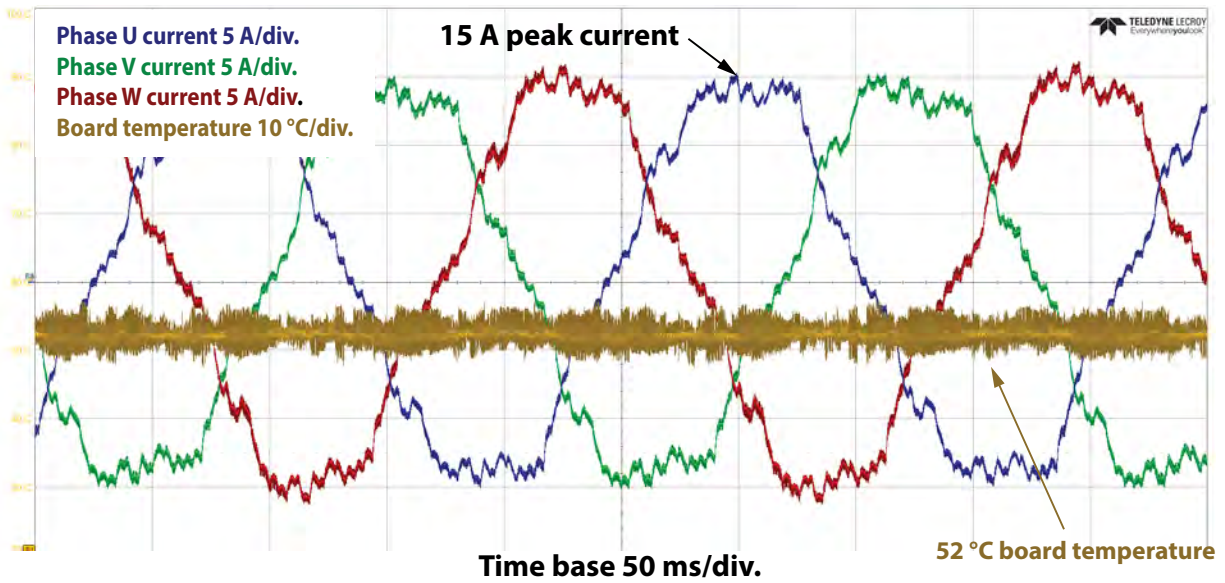


Figure 9. Phase current waveforms and board temperature

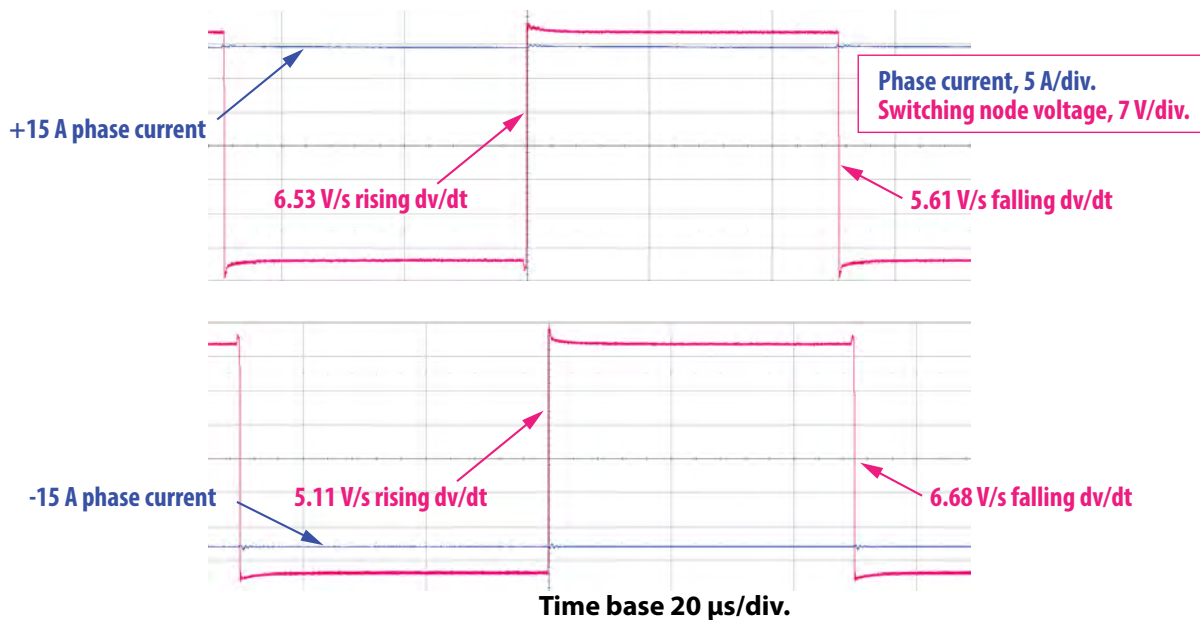


Figure 10. Measured slew rate on rising and falling switch-node transitions at 15 A peak positive and negative phase current

THERMAL PERFORMANCE

The thermal performance summary of the EPC9193HC and of the EPC9193 boards is depicted in figure 11.

When operated on a motor bench at ambient temperature of 26°C, 100 kHz PWM, 48 V_{DC} supply and natural convection, the EPC9193 can deliver 16 A_{RMS} per phase without a heatsink and 21 A_{RMS} per phase with a heatsink attached with a temperature rise below 50°C from eGaN FET case to ambient.

When operated on a motor bench at ambient temperature of 26°C, 100 kHz PWM, 48 V_{DC} supply and natural convection, the EPC9193HC can deliver 18 A_{RMS} per phase without a heatsink and 25 A_{RMS} per phase with a heatsink attached with a temperature rise below 50°C from eGaN FET case to ambient.

The temperature was recorded at steady state. Motor drive operating points at PWM = 20, 50, 100 kHz, deadtime = 50 ns, with and without heatsink at 26°C ambient temperature. Under natural convection.

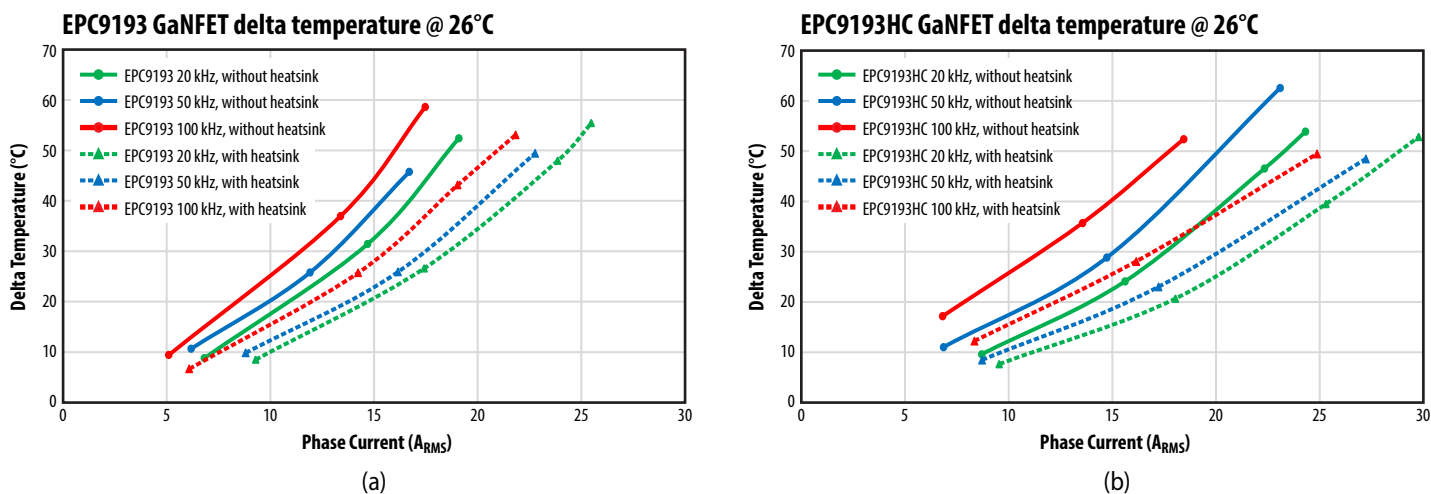


Figure 11: EPC9193 (a) and EPC9193HC (b) GaNFET temperature increase vs. the ambient temperature (26°C)

The graph in Figure 12 shows the correlation between the measured temperature by the on-board temperature sensor placed beneath the phase-V eGaN FETs on the bottom side of the PCB and the infra-red camera die case temperature for same eGaN IC that is measured without a heatsink and with only natural convection cooling. Figure 13 shows the location of the temperature sensor used to measure the bottom side of the PCB temperature.

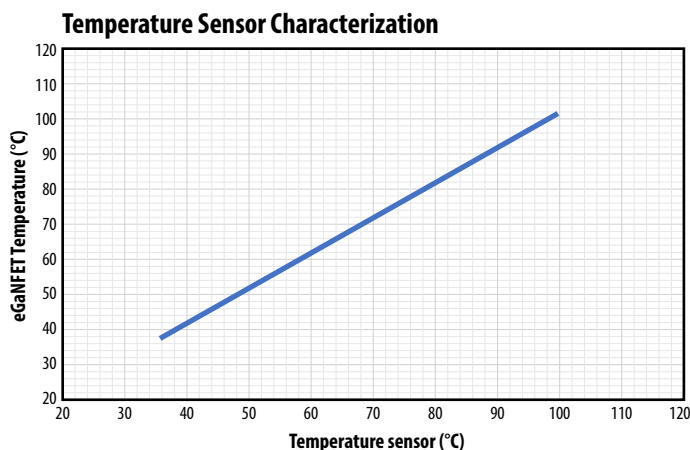


Figure 12: eGaN FET case temperature vs. temperature sensor placed on bottom of the PCB. Operation under natural convection without heatsink.

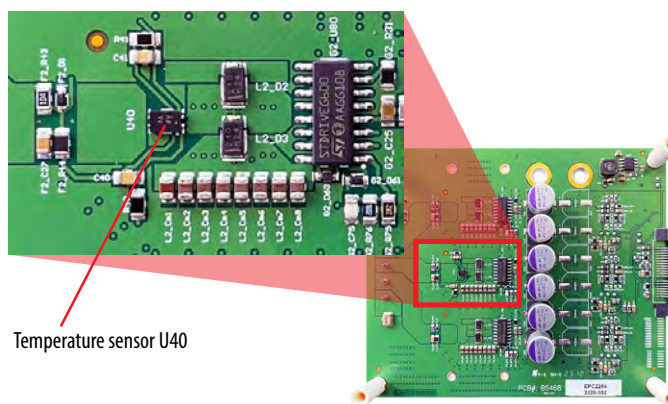


Figure 13: Temperature sensor location on the bottom side of the PCB

For support files including schematic, Bill of Materials (BOM), and gerber files please visit the EPC9193 landing page at: <https://epc-co.com/epc/Products/DemoBoards/EPC9193>

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